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Applicant: Itakura et al.
Appl. No.: 10/709,305
Filing Date: April 28, 2004
Title: SOLDER FILM MANUFACTURING METHOD, HEAT SINK FURNISHED WITH
SOLDER FILM, AND SEMICONDUCTOR-DEVICE-AND-HEAT-SINK JUNCTION
Attorney Docket No.: 39.036
Pub. No.: US 2005/0089700 A1
Pub. Date: April 28, 2005

This is a decision on the request for a corrected patent application publication under 37 CFR 1.221(b), filed on June 28, 2005, for the above-identified application.

The request is granted.

The corrected patent application publication will be published in due course, unless the patent issues before the application is republished.

Inquiries relating to this matter may be directed to Mark Polutta at (571) 272-7709 (voice).

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for Patent Examination Policy